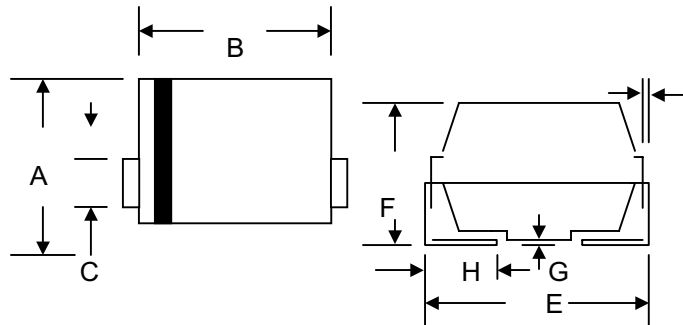


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**Features**

- Glass Passivated Die Construction
- Ideally Suited for Automatic Assembly
- Low Forward Voltage Drop, High Efficiency
- Surge Overload Rating to 30A Peak D
- Low Power Loss
- Ultra-Fast Recovery Time
- Plastic Case Material has UL Flammability Classification Rating 94V-O



**Mechanical Data**

- Case: Molded Plastic
- Terminals: Solder Plated, Solderable per MIL-STD-750, Method 2026
- Polarity: Cathode Band or Cathode Notch
- Marking: Type Number
- Weight: 0.093 grams (approx.)

SMB/DO-214AA		
Dim	Min	Max
A	3.30	3.94
B	4.06	4.70
C	1.91	2.11
D	0.152	0.305
E	5.08	5.59
F	2.13	2.44
G	0.051	0.203
H	0.76	1.27
All Dimensions in mm		

**Maximum Ratings and Electrical Characteristics** @T<sub>A</sub>=25°C unless otherwise specified

Characteristic	Symbol	UF1A	UF1B	UF1D	UF1G	UF1J	UF1K	Unit	
Peak Repetitive Reverse Voltage	V <sub>RRM</sub>	50	100	200	400	600	800	V	
Working Peak Reverse Voltage	V <sub>RWM</sub>								
DC Blocking Voltage	V <sub>R</sub>								
RMS Reverse Voltage	V <sub>R(RMS)</sub>	35	70	140	280	420	560	V	
Average Rectified Output Current @T <sub>L</sub> = 100°C	I <sub>o</sub>	1.0						A	
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method) @T <sub>A</sub> = 55°C	I <sub>FSM</sub>	30						A	
Forward Voltage @I <sub>F</sub> = 1.0A	V <sub>FM</sub>	1.0			1.4	1.7		V	
Peak Reverse Current @T <sub>A</sub> = 25°C At Rated DC Blocking Voltage @T <sub>A</sub> = 100°C	I <sub>RM</sub>				10				μA
					500				
Reverse Recovery Time (Note 1)	t <sub>rr</sub>	50				100		nS	
Typical Junction Capacitance (Note 2)	C <sub>j</sub>	15						pF	
Typical Thermal Resistance (Note 3)	R <sub>θJL</sub>	30						K/W	
Operating and Storage Temperature Range	T <sub>j</sub> , T <sub>STG</sub>	-50 to +150						°C	

Note: 1. Measured with I<sub>F</sub> = 0.5A, I<sub>R</sub> = 1.0A, I<sub>rr</sub> = 0.25A,  
2. Measured at 1.0 MHz and applied reverse voltage of 4.0 V DC.  
3. Mounted on P.C. Board with 8.0mm<sup>2</sup> land area.

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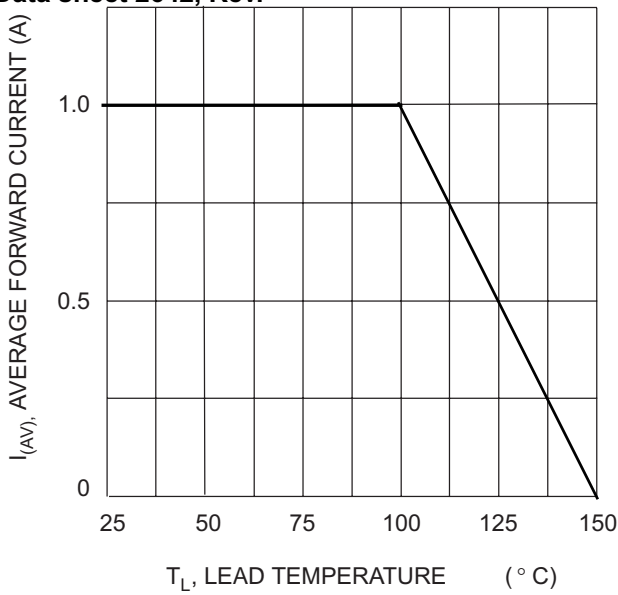


Fig. 1 Forward Current Derating Curve

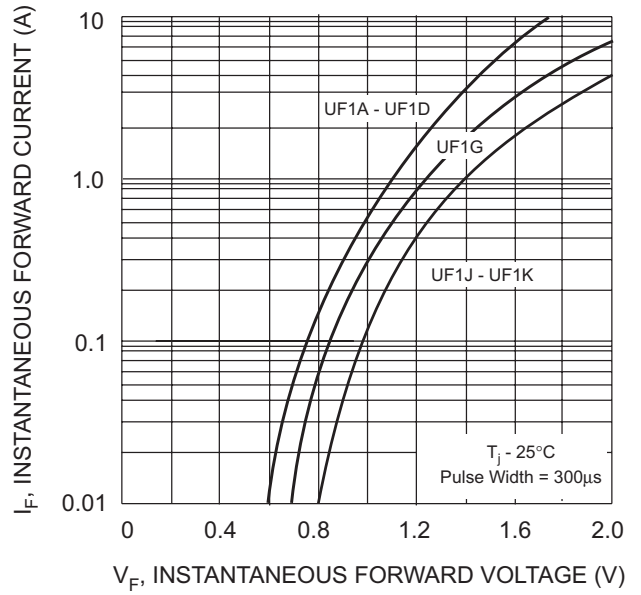


Fig. 2 Typical Forward Characteristics

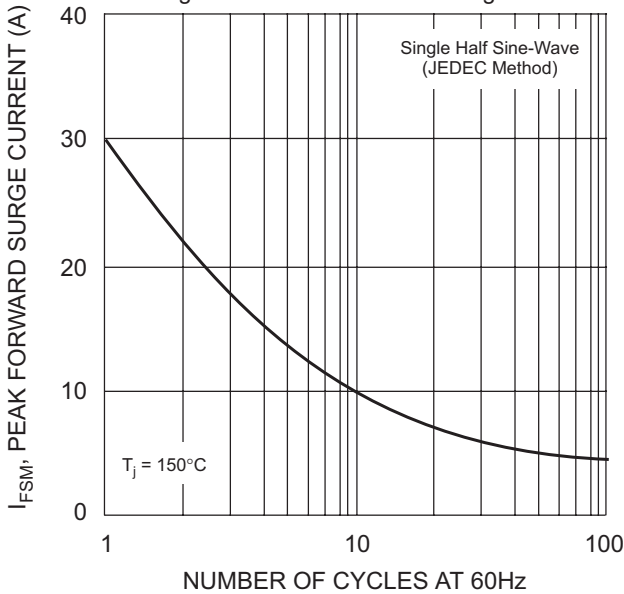


Fig. 3 Forward Surge Current Derating Curve

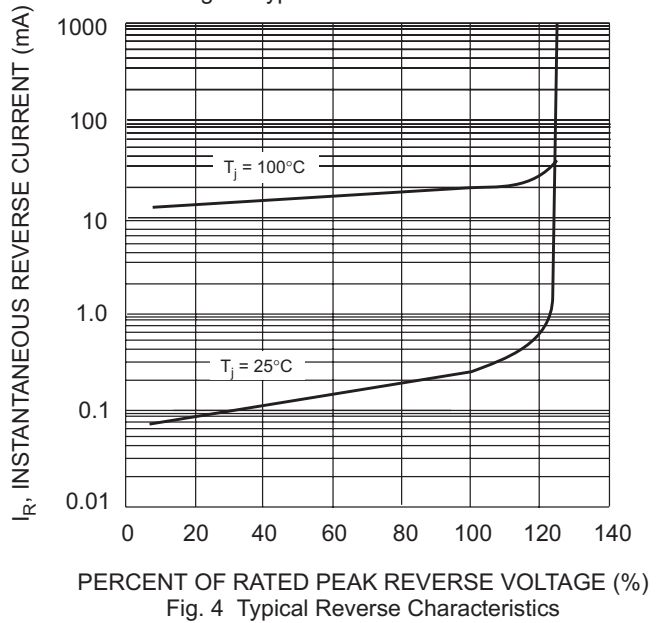
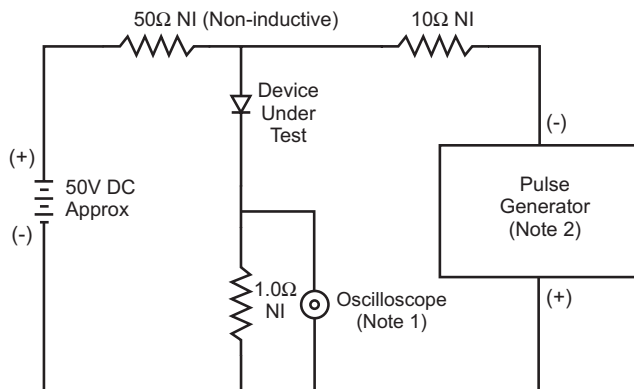


Fig. 4 Typical Reverse Characteristics



- Notes:
1. Rise Time = 7.0ns max. Input Impedance = 1.0MΩ, 22pF.
  2. Rise Time = 10ns max. Input Impedance = 50Ω.

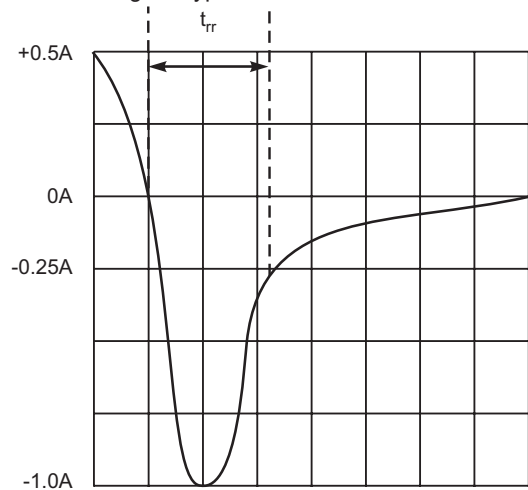


Fig. 5 Reverse Recovery Time Characteristic and Test Circuit

**TECHNICAL DATA**

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